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Part Number: [0780013344](#)
Status: **Active**
Overview: [MiniDIMM Sockets](#)
Description: 0.60mm Pitch miniDIMM DDR3 Socket, Surface Mount, Reverse Right-Angle, with Off-White Latches, 1.5V Voltage Key, 244 Circuits, Type B Tray Packaging, Lead-Free

Documents:

3D Model	Application Specification AS-87782-001-001 (PDF)
Drawing (PDF)	Packaging Specification PK-78001-003-001 (PDF)
Product Specification PS-78001-001-001 (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

Application tooling part link

Application Tooling Part Link	62100-1900
Application Tooling Part Link	62100-1950

General

Product Family	Memory Module Sockets
Series	78001
Component Type	Socket
JEDEC Outline	MO-244
Overview	MiniDIMM Sockets
Product Name	MiniDIMM
UPC	883906425890

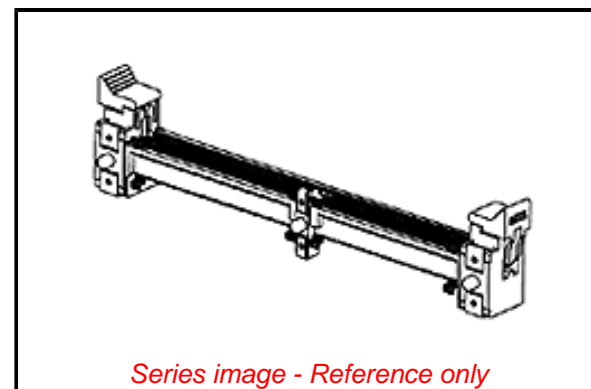
Physical

Circuits (Loaded)	244
Circuits (maximum)	244
Durability (mating cycles max)	25
Entry Angle	90° Angle (Side Entry)
Flammability	94V-0
Housing Color	Black
Keying to Mating Part	Yes
Latch Color	Natural (Off-White)
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	10.166/g
PCB Locator	Yes
PCB Retention	Yes
Packaging Type	Tray
Pitch - Mating Interface	0.60mm
Pitch - Termination Interface	0.60mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-55° to +85°C
Termination Interface: Style	Surface Mount

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	30V
Voltage Key	1.5V

Solder Process Data



EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per -
D(2021)4569-DC (8
July 2021)

Halogen-Free

Status

Not Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

China RoHS

Green Image

Not Relevant

Not Contained

Search Parts in this Series

[78001 Series](#)

Mates With

JEDEC MO-258 Modules

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
MiniDIMM Memory Card Extraction Tool	621001900
MiniDIMM Memory Card Insertion Tool	621001950

Duration at Max. Process Temperature (seconds)	005
Lead-freeProcess Capability	REFLOW
Max. Cycles at Max. Process Temperature	002
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Application Specification	AS-87782-001-001
Electrical Model Document	EE-78001-001-001
Packaging Specification	PK-78001-003-001
Product Specification	PS-78001-001-001
S-Parameter Model	SP-78001-001-001
Sales Drawing	SD-78001-003-001

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